

TBB1012

Twin Built in Biasing Circuit MOS FET IC UHF/VHF RF Amplifier

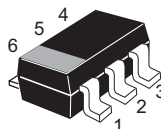
R07DS0317EJ0400
Rev.4.00
Jan 10, 2014

Features

- Small SMD package CMPAK-6 built in twin BBFET; To reduce using parts cost & PC board space.
- Very useful for total tuner cost reduction.
- Suitable for World Standard Tuner RF amplifier.
- High gain
- Low noise
- Low output capacitance
- Power supply voltage: 5 V

Outline

RENESAS Package code: PTSP0006JA-A
(Package name: CMPAK-6)



1. Drain(1)
2. Source
3. Drain(2)
4. Gate-1(2)
5. Gate-2
6. Gate-1(1)

- Notes:
1. Marking is "MM".
 2. TBB1012 is individual type number of Renesas TWIN BBFET.

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DS}	6	V
Gate1 to source voltage	V_{G1S}	+6 -0	V
Gate2 to source voltage	V_{G2S}	+6 -0	V
Drain current	I_D	30	mA
Channel power dissipation	P_{ch} ^{Note3}	250	mW
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 3. Value on the glass epoxy board (50mm × 40mm × 1mm).

Electrical Characteristics

• FET1

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	6	—	—	V	$I_D = 200 \mu A, V_{G1S} = V_{G2S} = 0$
Gate1 to source breakdown voltage	$V_{(BR)G1SS}$	+6	—	—	V	$I_{G1} = +10 \mu A, V_{G2S} = V_{DS} = 0$
Gate2 to source breakdown voltage	$V_{(BR)G2SS}$	+6	—	—	V	$I_{G2} = +10 \mu A, V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff current	I_{G1SS}	—	—	+100	nA	$V_{G1S} = +5 V, V_{G2S} = V_{DS} = 0$
Gate2 to source cutoff current	I_{G2SS}	—	—	+100	nA	$V_{G2S} = +5 V, V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff voltage	$V_{G1S(off)}$	0.5	0.8	1.1	V	$V_{DS} = 5 V, V_{G2S} = 4 V, I_D = 100 \mu A$
Gate2 to source cutoff voltage	$V_{G2S(off)}$	0.4	0.7	1.0	V	$V_{DS} = 5 V, V_{G1S} = 5 V, I_D = 100 \mu A$
Drain current	$I_{D(op)}$	12	16	20	mA	$V_{DS} = 5 V, V_{G1} = 5 V$ $V_{G2S} = 4 V, R_G = 100 k\Omega$
Forward transfer admittance	$ y_{fs} $	27	32	38	mS	$V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} = 4 V,$ $f = 1 kHz, R_G = 100 k\Omega$
Input capacitance	C_{iss}	1.2	1.6	2.0	pF	$V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} = 4 V,$ $f = 1 MHz, R_G = 100 k\Omega$
Output capacitance	C_{oss}	0.7	1.1	1.5	pF	
Power gain	PG	15	20.5	25	dB	$V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} = 4 V,$ $R_G = 100 k\Omega, f = 900 MHz$
Noise figure	NF	—	1.95	2.7	dB	

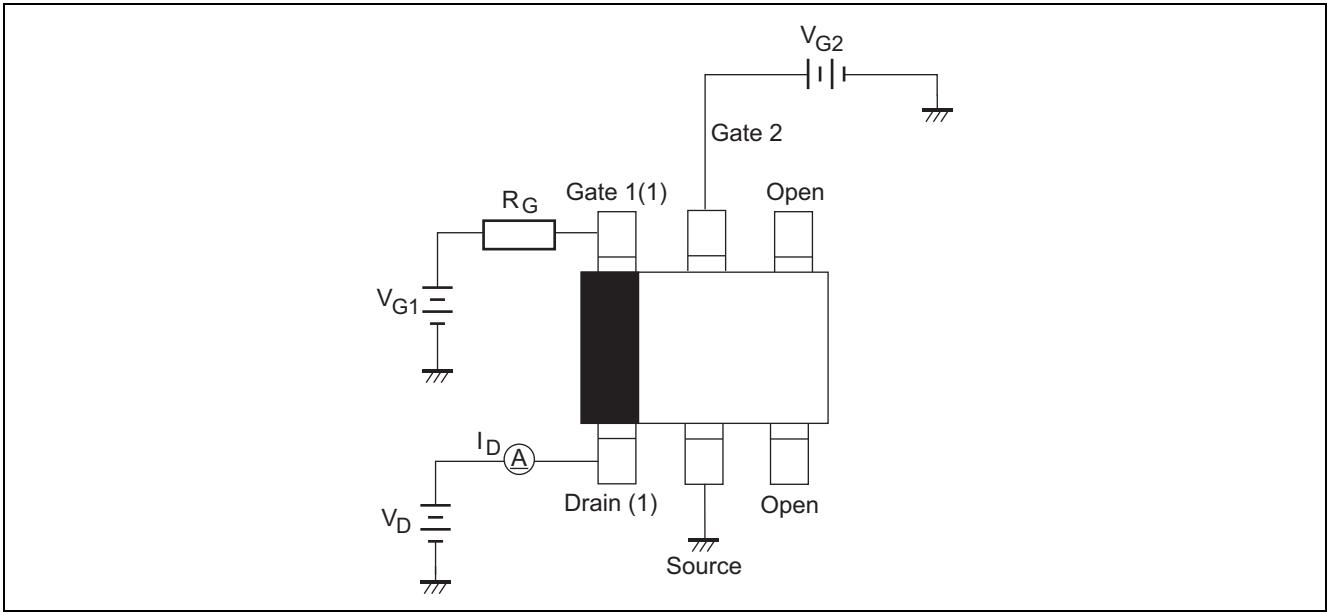
• FET2

(Ta = 25°C)

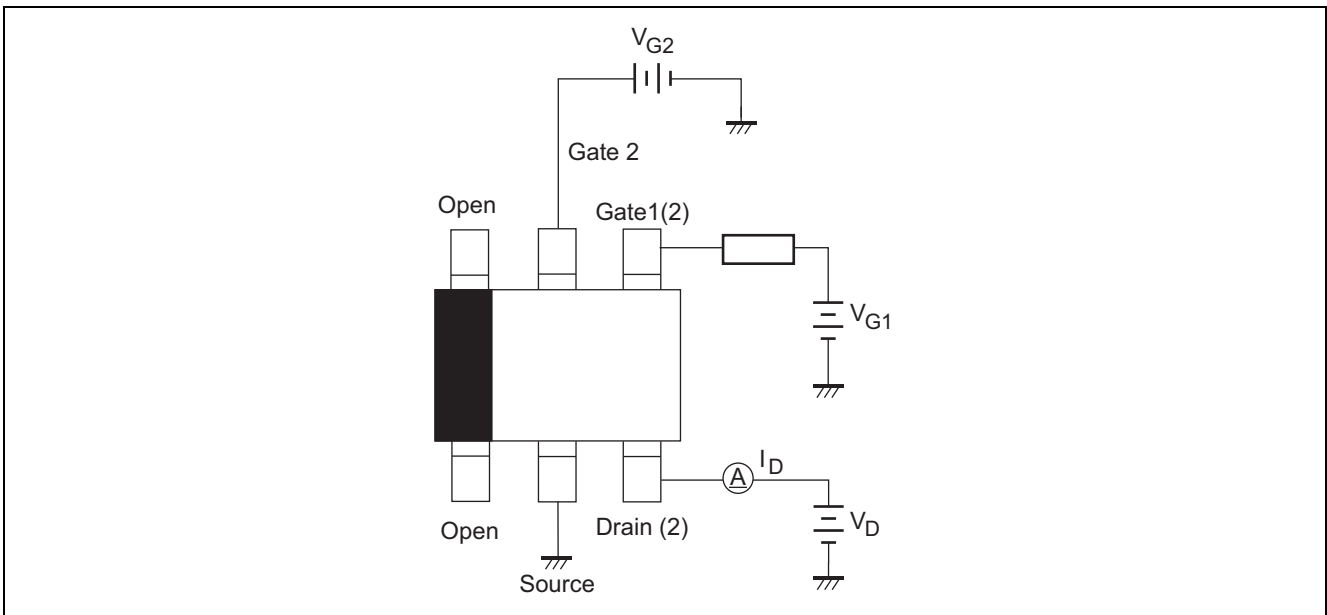
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	6	—	—	V	$I_D = 200 \mu A, V_{G1S} = V_{G2S} = 0$
Gate1 to source breakdown voltage	$V_{(BR)G1SS}$	+6	—	—	V	$I_{G1} = +10 \mu A, V_{G2S} = V_{DS} = 0$
Gate2 to source breakdown voltage	$V_{(BR)G2SS}$	+6	—	—	V	$I_{G2} = +10 \mu A, V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff current	I_{G1SS}	—	—	+100	nA	$V_{G1S} = +5 V, V_{G2S} = V_{DS} = 0$
Gate2 to source cutoff current	I_{G2SS}	—	—	+100	nA	$V_{G2S} = +5 V, V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff voltage	$V_{G1S(off)}$	0.5	0.8	1.1	V	$V_{DS} = 5 V, V_{G2S} = 4 V, I_D = 100 \mu A$
Gate2 to source cutoff voltage	$V_{G2S(off)}$	0.4	0.7	1.0	V	$V_{DS} = 5 V, V_{G1S} = 5 V, I_D = 100 \mu A$
Drain current	$I_{D(op)}$	13	17	21	mA	$V_{DS} = 5 V, V_{G1} = 5 V$ $V_{G2S} = 4 V, R_G = 82 k\Omega$
Forward transfer admittance	$ y_{fs} $	25	30	35	mS	$V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} = 4 V,$ $f = 1 kHz, R_G = 82 k\Omega$
Input capacitance	C_{iss}	2.3	2.7	3.1	pF	$V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} = 4 V,$ $f = 1 MHz, R_G = 82 k\Omega$
Output capacitance	C_{oss}	0.9	1.3	1.7	pF	
Power gain	PG	24	29.5	34	dB	$V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} = 4 V,$ $R_G = 82 k\Omega, f = 200 MHz$
Noise figure	NF	—	0.95	1.6	dB	

DC Biasing Circuit for Operating Characteristic Items ($I_{D(op)}$, $|y_{fs}|$, C_{iss} , C_{oss} , NF , PG)

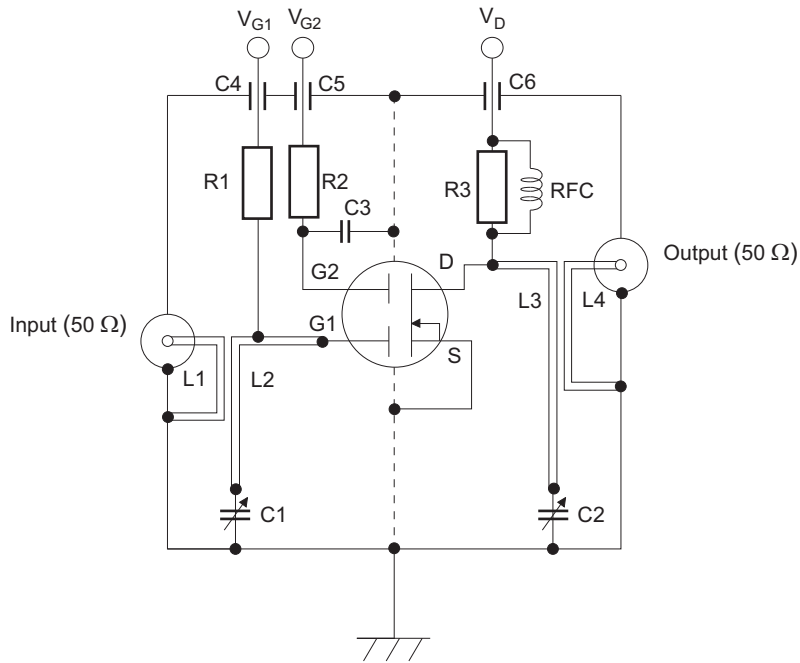
• Measurement of FET1



• Measurement of FET2

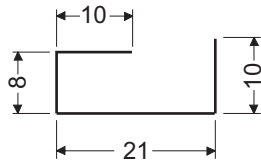


900 MHz Power Gain, Noise Figure Test Circuit

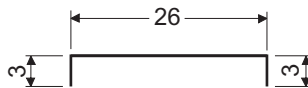


- C1, C2 : Variable Capacitor (10 pF MAX)
- C3 : Disk Capacitor (1000 pF)
- C4 ~ C6 : Air Capacitor (1000 pF)
- R1 : 100 kΩ
- R2 : 47 kΩ
- R3 : 4.7 kΩ

L1:

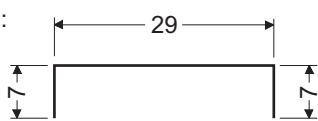


L2:

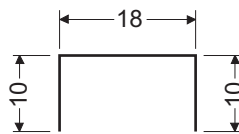


(φ 1 mm Copper wire)
Unit: mm

L3:

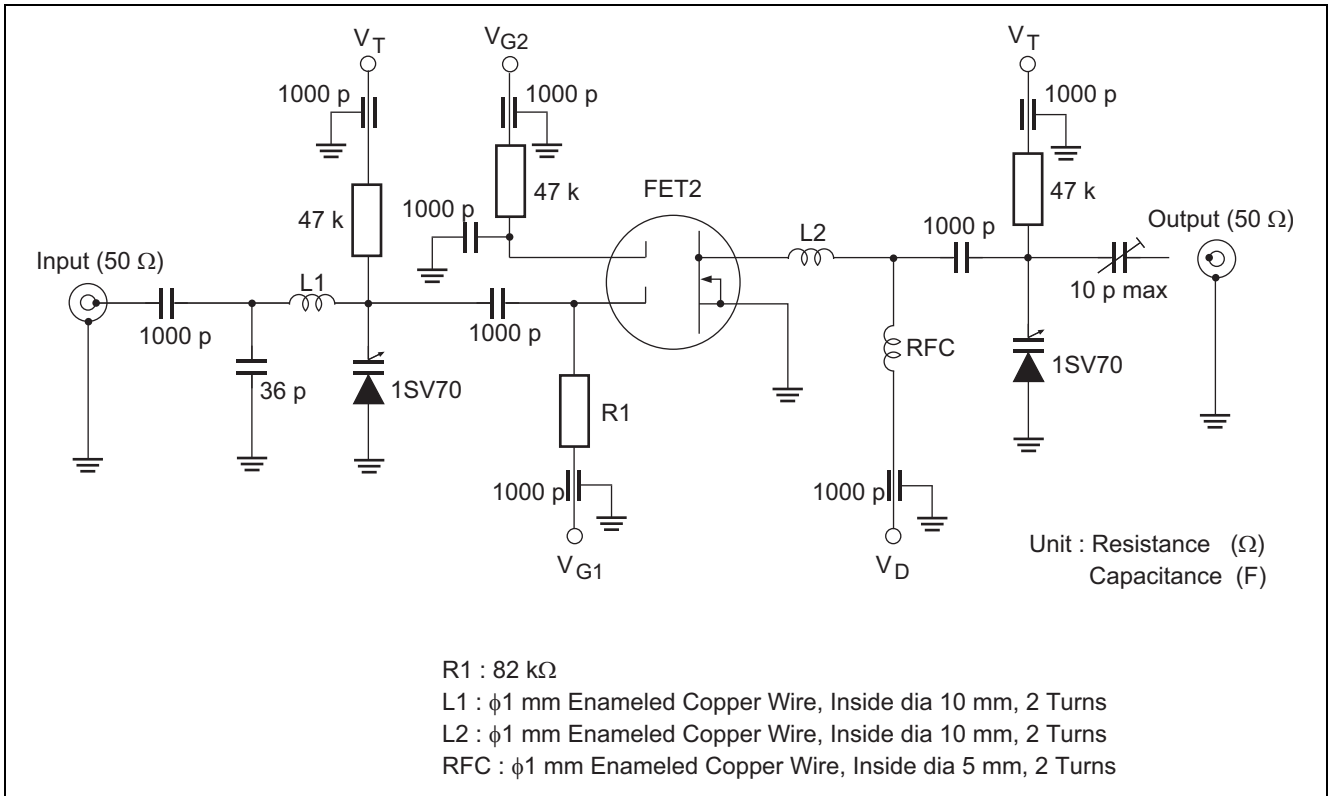


L4:



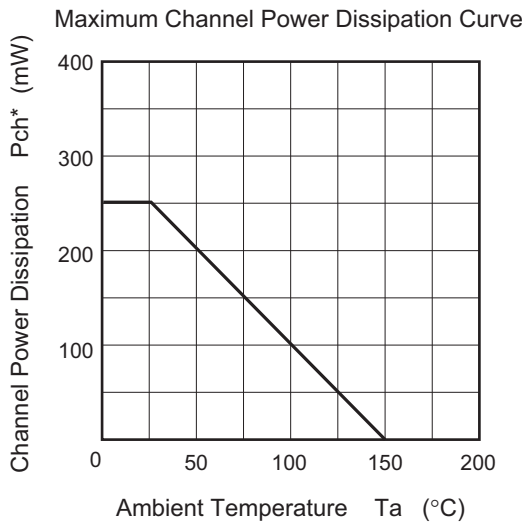
RFC : φ1 mm Copper wire with enamel 4 turns inside dia 6 mm

200 MHz Power Gain, Noise Figure Test Circuit

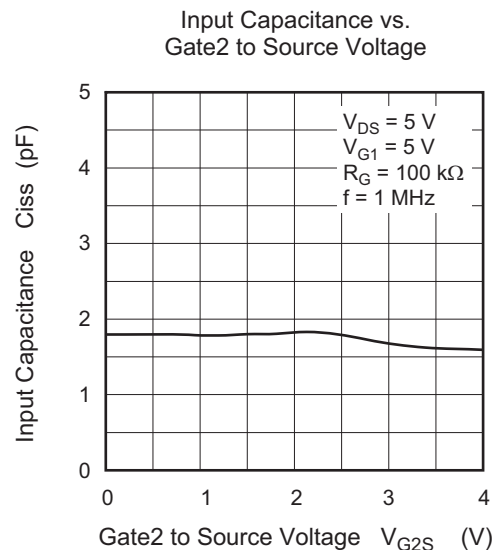
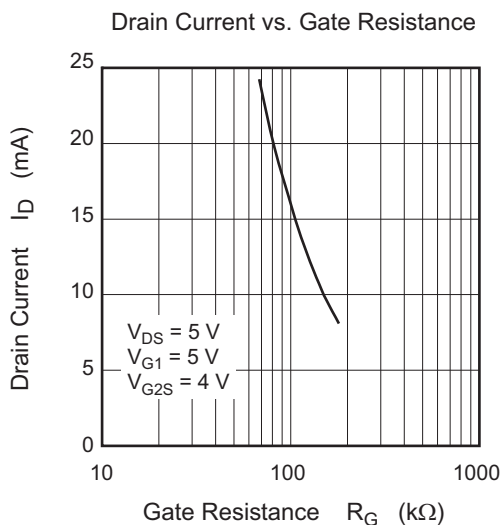
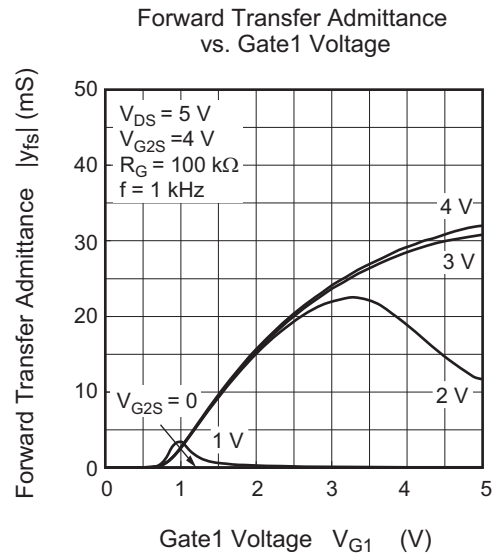
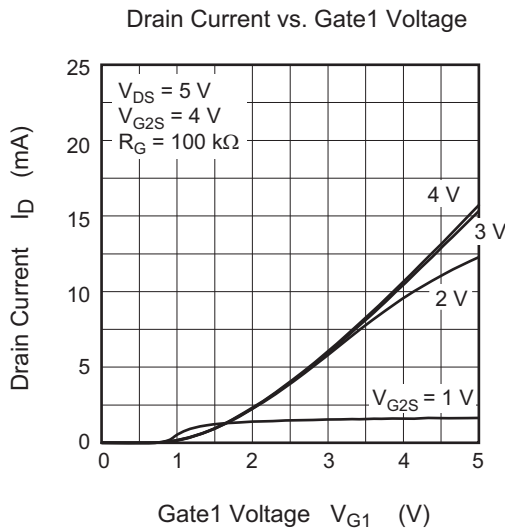
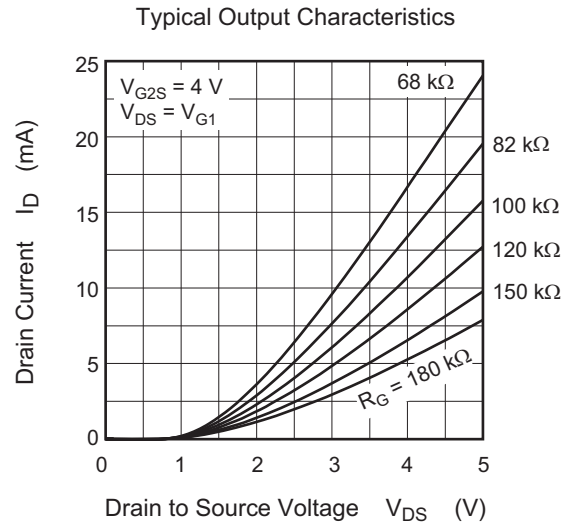


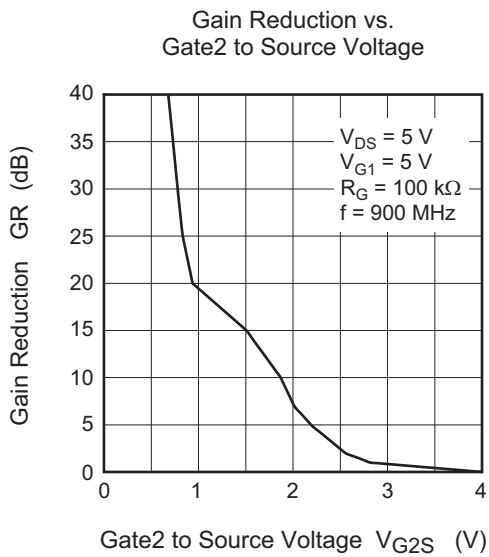
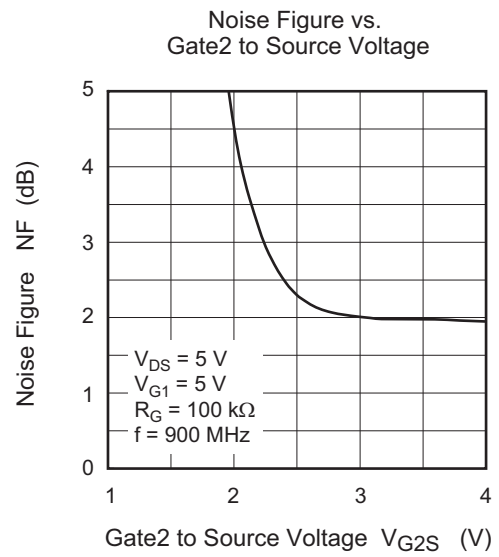
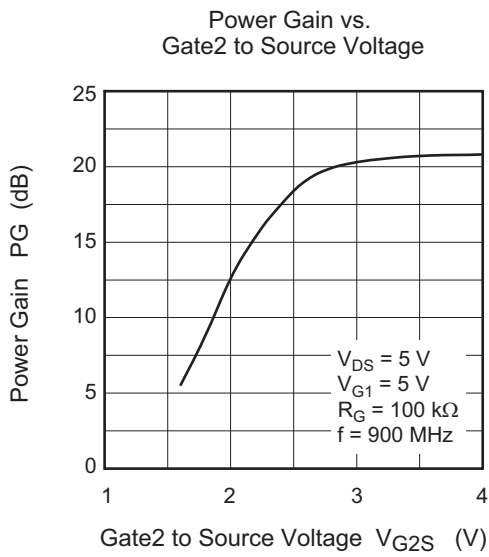
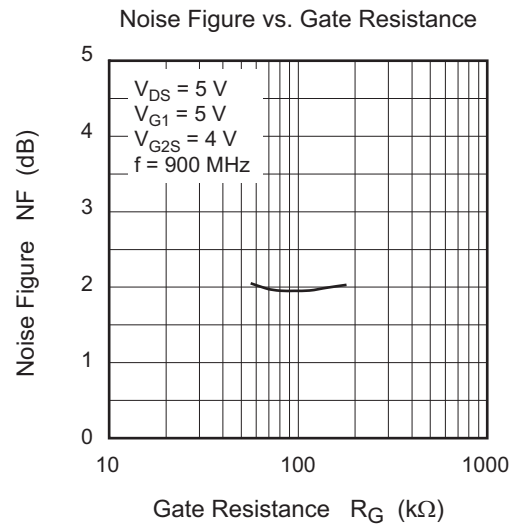
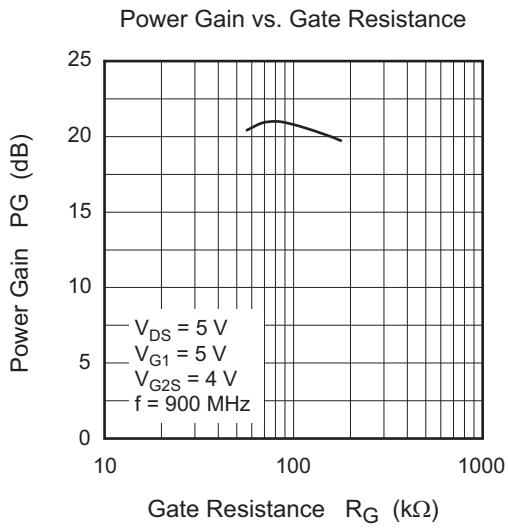
Main Characteristics

• FET1

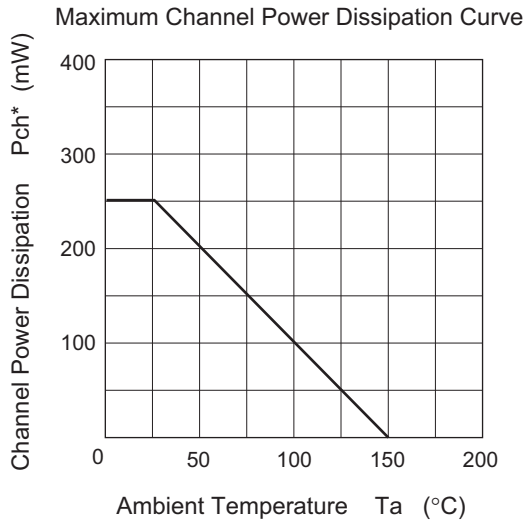


* Value on the glass epoxy board (50 mm × 40 mm × 1 mm)

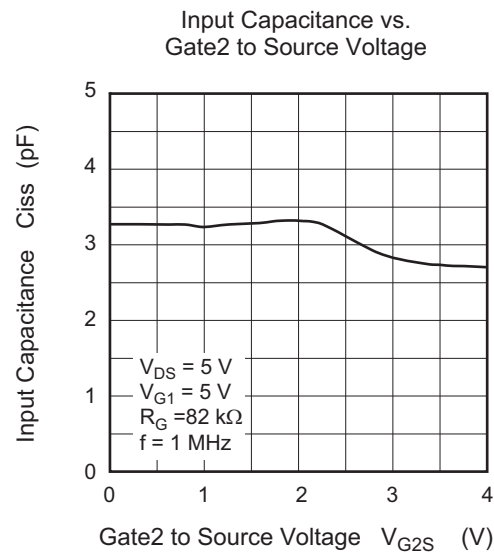
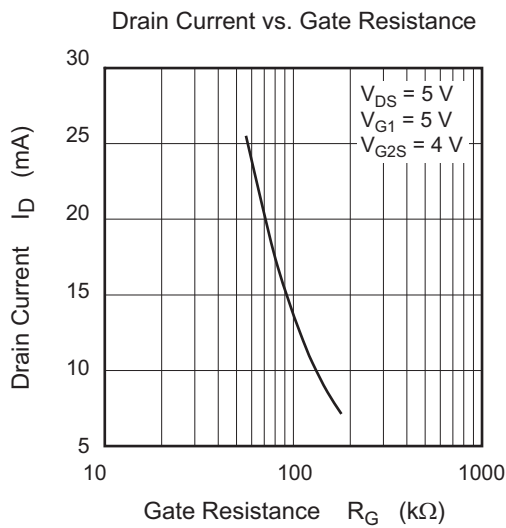
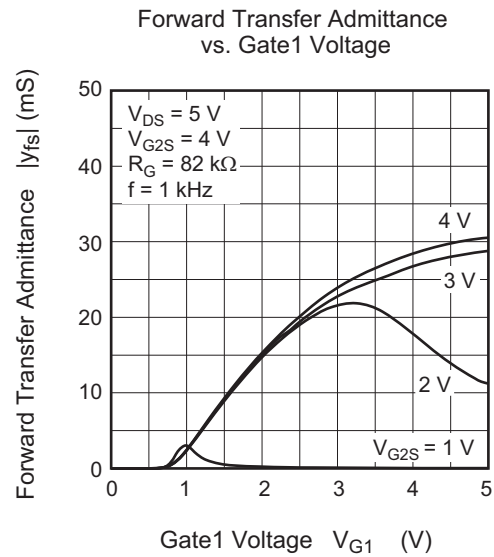
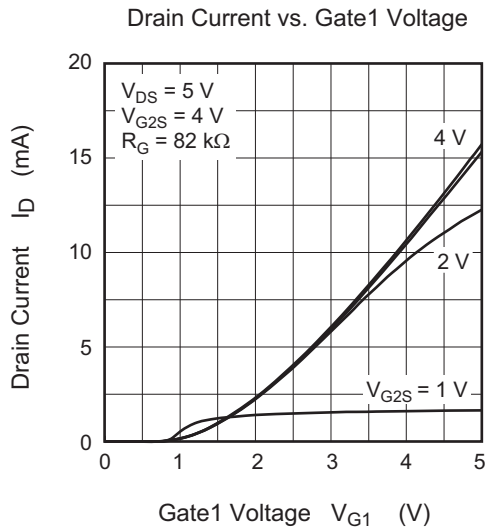
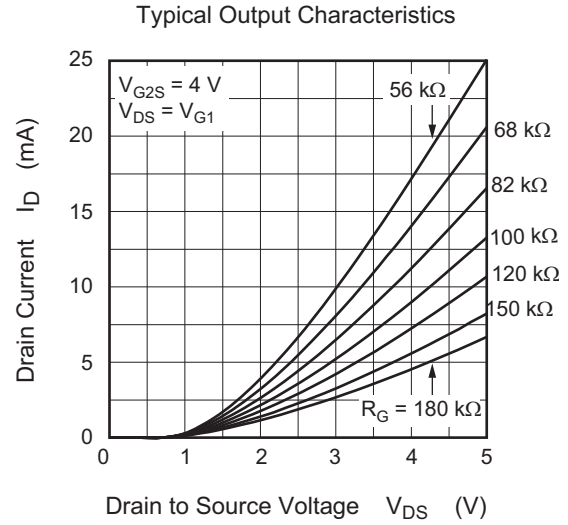


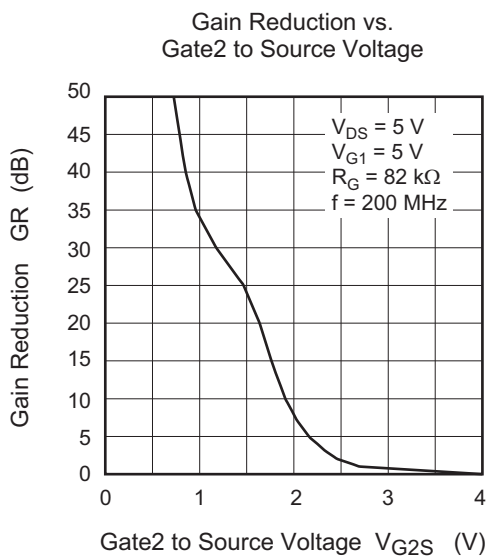
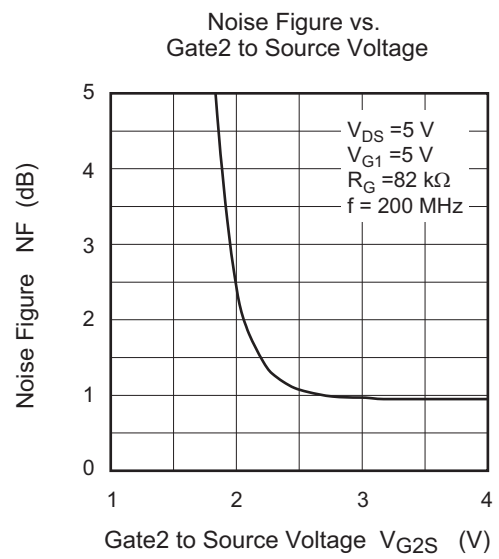
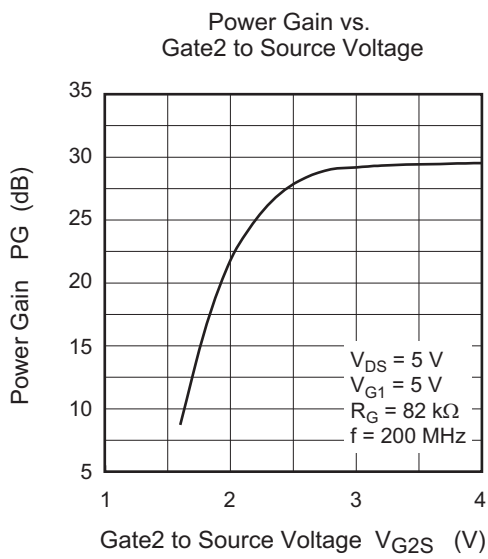
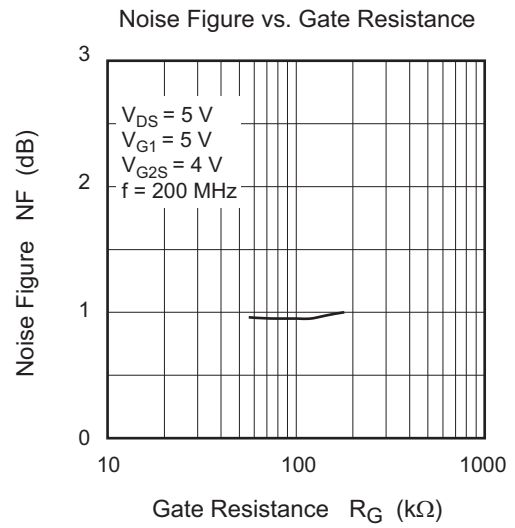
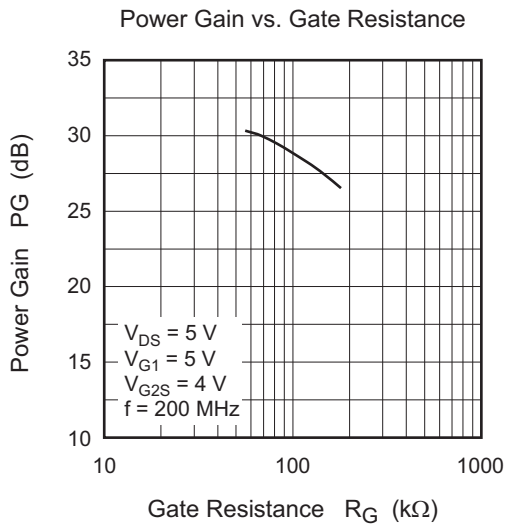


• FET2



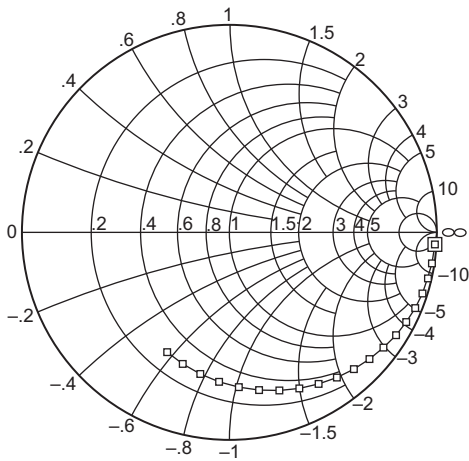
* Value on the glass epoxy board (50 mm × 40 mm × 1 mm)





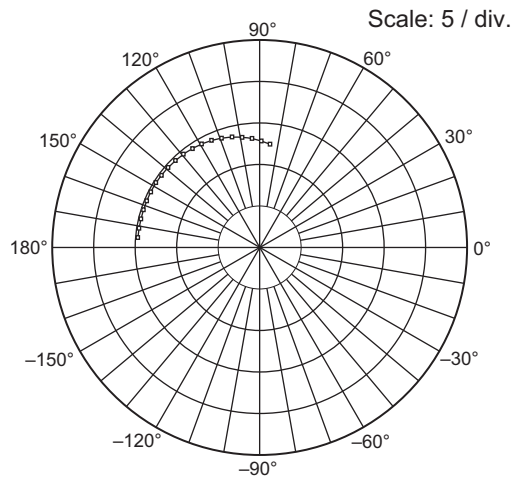
• FET1

S₁₁ Parameter vs. Frequency



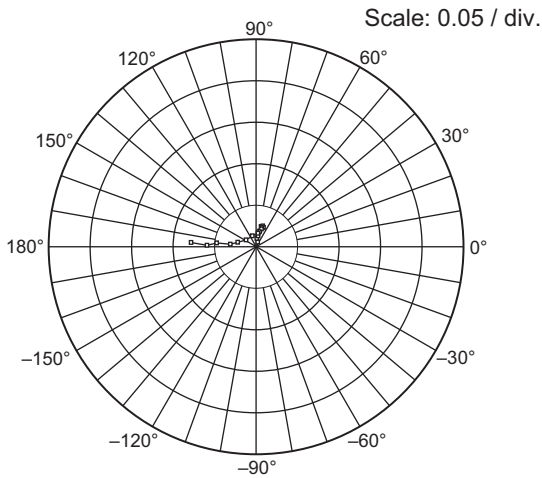
Test condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$,
 $V_{G2S} = 4\text{ V}$, $R_G = 100\text{ k}\Omega$
 0.05 to 1.05 GHz (0.05 GHz step)

S₂₁ Parameter vs. Frequency



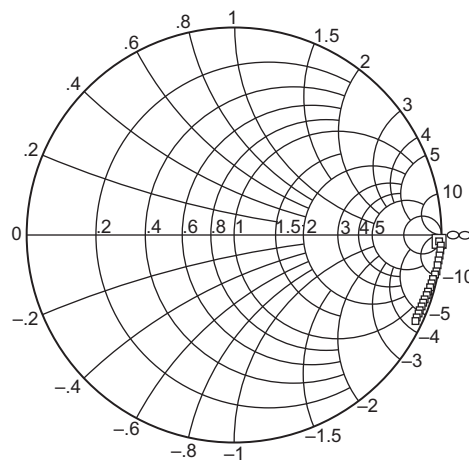
Test condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$,
 $V_{G2S} = 4\text{ V}$, $R_G = 100\text{ k}\Omega$
 0.05 to 1.05 GHz (0.05 GHz step)

S₁₂ Parameter vs. Frequency



Test condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$,
 $V_{G2S} = 4\text{ V}$, $R_G = 100\text{ k}\Omega$
 0.05 to 1.05 GHz (0.05 GHz step)

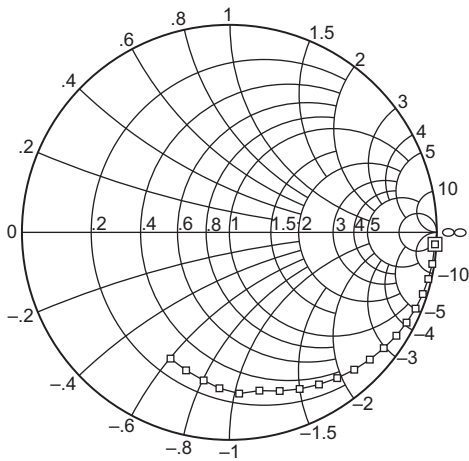
S₂₂ Parameter vs. Frequency



Test condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$,
 $V_{G2S} = 4\text{ V}$, $R_G = 100\text{ k}\Omega$
 0.05 to 1.05 GHz (0.05 GHz step)

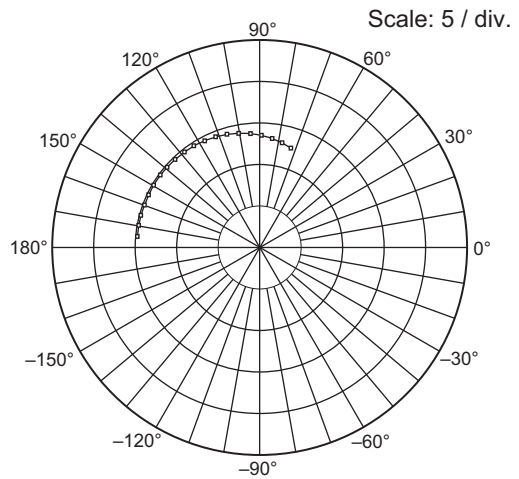
• FET2

S11 Parameter vs. Frequency



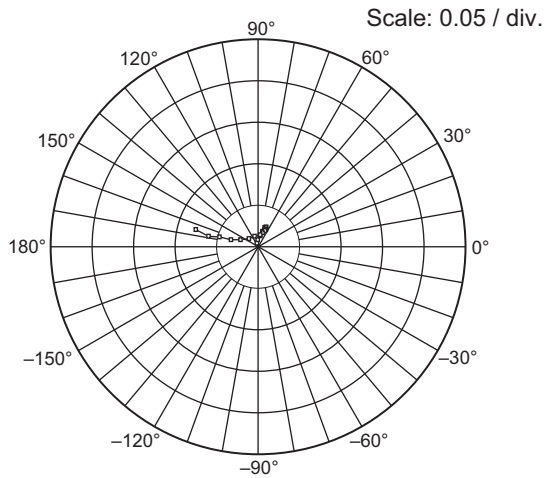
Test condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$,
 $V_{G2S} = 4\text{ V}$, $R_G = 82\text{ k}\Omega$
 0.05 to 1.05 GHz (0.05 GHz step)

S21 Parameter vs. Frequency



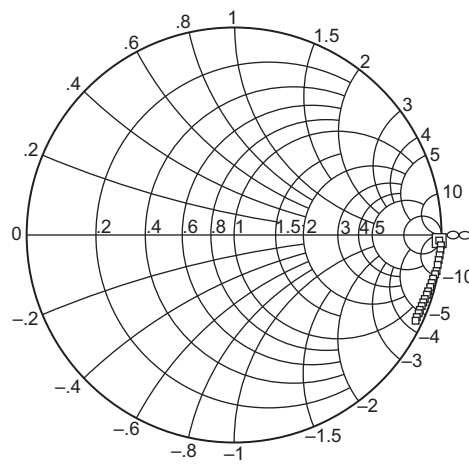
Test condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$,
 $V_{G2S} = 4\text{ V}$, $R_G = 82\text{ k}\Omega$
 0.05 to 1.05 GHz (0.05 GHz step)

S12 Parameter vs. Frequency



Test condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$,
 $V_{G2S} = 4\text{ V}$, $R_G = 82\text{ k}\Omega$
 0.05 to 1.05 GHz (0.05 GHz step)

S22 Parameter vs. Frequency



Test condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$,
 $V_{G2S} = 4\text{ V}$, $R_G = 82\text{ k}\Omega$
 0.05 to 1.05 GHz (0.05 GHz step)

S parameter

• FET1

 $(V_{DS} = 5\text{ V}, V_{G1} = 5\text{ V}, V_{G2S} = 4\text{ V}, R_G = 100\text{ k}\Omega, Z_o = 50\ \Omega)$

Freq. (MHz)	S11		S21		S12		S22	
	Mag	Deg	Mag	Deg	Mag	Deg	Mag	Deg
50	0.994	-4.3	2.97	175.6	0.001	74.4	0.999	-1.3
100	0.990	-8.8	2.97	171.1	0.002	89.6	0.998	-2.8
150	0.985	-13.1	2.97	166.7	0.002	81.5	0.997	-4.2
200	0.978	-17.6	2.97	162.2	0.003	81.6	0.995	-5.6
250	0.970	-22.2	2.97	157.8	0.004	77.8	0.993	-7.0
300	0.958	-26.9	2.96	153.1	0.005	76.9	0.992	-8.3
350	0.946	-31.7	2.97	148.1	0.005	73.8	0.991	-10.1
400	0.930	-36.8	2.96	143.8	0.005	72.9	0.987	-11.0
450	0.913	-42.1	2.95	139.0	0.005	69.4	0.982	-12.4
500	0.894	-47.7	2.94	134.2	0.004	73.3	0.980	-13.6
550	0.873	-53.4	2.93	129.4	0.004	73.7	0.978	-14.8
600	0.850	-59.5	2.91	124.3	0.003	78.4	0.973	-16.2
650	0.826	-65.8	2.89	119.4	0.003	83.8	0.972	-17.2
700	0.801	-72.4	2.85	114.4	0.003	113.5	0.969	-18.5
750	0.775	-79.2	2.81	109.4	0.003	151.7	0.968	-19.6
800	0.749	-86.4	2.77	104.3	0.005	169.5	0.967	-20.7
850	0.723	-93.8	2.71	99.3	0.006	176.7	0.965	-22.0
900	0.698	-101.4	2.66	94.4	0.010	176.0	0.966	-22.9
950	0.674	-109.3	2.59	89.4	0.012	179.6	0.965	-24.2
1000	0.651	-117.2	2.52	84.7	0.016	177.3	0.967	-25.3

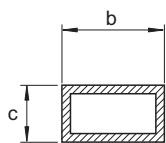
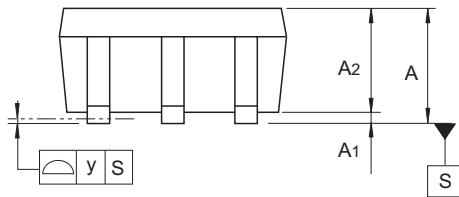
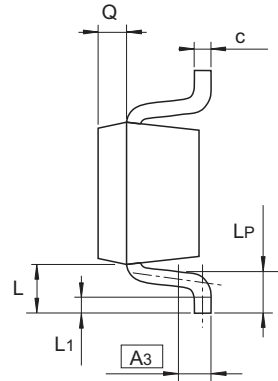
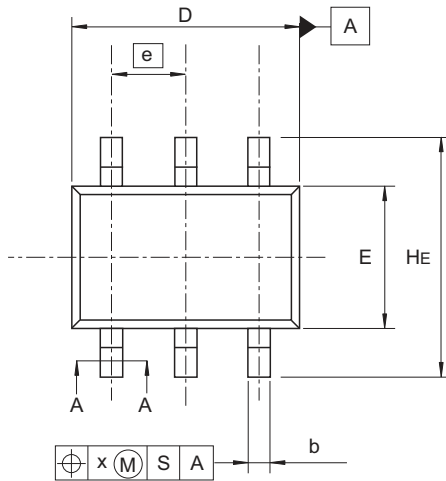
• FET2

 $(V_{DS} = 5\text{ V}, V_{G1} = 5\text{ V}, V_{G2S} = 4\text{ V}, R_G = 82\text{ k}\Omega, Z_o = 50\ \Omega)$

Freq (MHz)	S11		S21		S12		S22	
	Mag	Deg	Mag	Deg	Mag	Deg	Mag	Deg
50	0.986	-4.8	2.96	175.1	0.001	109.6	1.000	-1.9
100	0.983	-10.1	2.96	169.9	0.002	93.5	0.998	-4.0
150	0.979	-14.9	2.96	165.0	0.003	77.5	0.998	-5.9
200	0.971	-20.0	2.95	159.9	0.004	73.2	0.995	-8.0
250	0.963	-25.2	2.96	154.7	0.004	72.4	0.994	-9.9
300	0.951	-30.4	2.96	149.6	0.004	69.1	0.992	-11.9
350	0.937	-35.9	2.96	143.9	0.005	70.2	0.991	-14.2
400	0.923	-41.6	2.95	139.0	0.005	67.3	0.987	-15.7
450	0.905	-47.4	2.95	133.8	0.005	66.2	0.982	-17.7
500	0.887	-53.7	2.93	128.2	0.004	64.6	0.981	-19.5
550	0.868	-60.0	2.92	122.9	0.004	65.8	0.977	-21.4
600	0.843	-66.6	2.90	117.3	0.003	71.3	0.973	-23.3
650	0.821	-73.6	2.88	111.6	0.003	79.4	0.972	-25.0
700	0.796	-80.6	2.85	106.1	0.003	109.7	0.969	-26.9
750	0.769	-88.1	2.80	100.5	0.003	139.9	0.967	-28.6
800	0.744	-95.9	2.76	94.7	0.004	159.6	0.966	-30.3
850	0.719	-103.8	2.71	89.2	0.007	166.6	0.964	-32.2
900	0.692	-112.2	2.65	83.6	0.010	166.5	0.965	-33.7
950	0.669	-120.7	2.58	78.0	0.012	168.6	0.964	-35.6
1000	0.646	-129.1	2.51	72.8	0.015	165.0	0.966	-37.3

Package Dimensions

JEITA Package Code	RENESAS Code	Previous Code	MASS (Typ) [g]
SC-88	PTSP0006JA-A	CMPAK-6 / CMPAK-6V	0.006



A-A Section

Reference Symbol	Dimensions in millimeters		
	Min	Nom	Max
A	0.8	—	1.1
A ₁	0	—	0.1
A ₂	0.8	0.9	1.0
A ₃	—	0.25	—
b	0.15	0.2	0.25
c	0.1	0.15	0.25
D	1.8	2.0	2.2
E	1.15	1.25	1.35
e	—	0.65	—
HE	2.0	2.1	2.2
L	0.3	—	0.7
L ₁	0.1	—	0.5
L _P	0.2	—	0.6
x	—	—	0.05
y	—	—	0.05
Q	—	0.25	—

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Ordering Information

Orderable Part Number	Quantity	Shipping Container
TBB1012MMTL-E TBB1012MMTL-H	3000 pcs	φ178mm reel, 8mm emboss taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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Renesas Electronics America Inc.
2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A.
Tel: +1-408-586-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited
1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada
Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 LanGao Rd., Putuo District, Shanghai, China
Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2886-9318, Fax: +852 2886-9022/9044

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei, Taiwan
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd.
12F., 234 Teheran-ro, Gangnam-Gu, Seoul, 135-080, Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5141